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SEMICONDUCTOR

$\label{eq:FCPF260N60E_F152} \begin{array}{l} \textbf{FCPF260N60E_F152} \\ \textbf{N-Channel SuperFET}^{\texttt{R}} \text{ II MOSFET} \\ \textbf{600 V, 15 A, 260 m} \Omega \end{array}$

Features

- 650 V @T_J = 150°C
- Max. R_{DS(on)} = 260 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 48 nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 129 pF)
- 100% Avalanche Tested

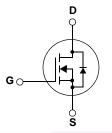
Aplications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply



Description

SuperFET[®]II MOSFET is Fairchild Semiconductor[®], s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET[®]II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FCPF260N60E_F152	Unit	
V _{DSS}	Drain to Source Voltage	Prain to Source Voltage				
V _{GSS}		- DC		±20	V	
	Gate to Source Voltage	- AC	(f > 1Hz)	±30	V	
ID	Droin Current	-Continuous ($T_C = 25^{\circ}C$)		15*	٨	
	Drain Current	-Continuous ($T_C = 100^{\circ}C$)		9.5*	A	
I _{DM}	Drain Current	- Pulsed	45*	Α		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			292.5	mJ	
I _{AR}	Avalanche Current (Note 1)		(Note 1)	3.0	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)		(Note 1)	1.56	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
	MOSFET dv/dt	100				
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		36	W	
	Power Dissipation	- Derate above 25°C		0.29	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C		
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCPF260N60E_F152	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.5	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	

July 2013

	Device Marking Device		Package	Eco Status	Pac	kaging T	уре	Quanti	ity
		FCPF260N60E_F152	TO-220F	•		Tube		50	
		"green" Eco Status, please visit: acteristics $T_C = 25^{\circ}C$			/green/r	ohs_gree	e <u>n.html</u> .		
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charact	teristic	S							
				$_{S} = 0V, I_{D} = 10mA, T_{J} = 25$	°C	600	-	-	V
BV _{DSS}	Drain to	o Source Breakdown Voltage	V _{GS}	$_{\rm S} = 0$ V, $I_{\rm D} = 10$ mA, $T_{\rm J} = 15$	0°C	650	-	-	V
ΔBV _{DSS} ΔT _J	Coeffic		-	$I_D = 10$ mA, Referenced to 25°C		-	0.67	-	V/ºC
BV _{DS}	Drain-S Voltage	Source Avalanche Breakdowr	۲ V _G s	_S = 0V, I _D = 15A		-	700	-	V
				_S = 480V, V _{GS} = 0V		-	-	10	
DSS	Zero G	Zero Gate Voltage Drain Current		$_{\rm S} = 480$ V, $T_{\rm C} = 125^{\rm o}$ C		-	-	10	μA
GSS	Gate to	Body Leakage Current	V _G	$_{\rm S}$ = ±20V, V _{DS} = 0V		-	1	±100	nA
On Charact	teristic	S							
V _{GS(th)}	Gate T	hreshold Voltage	VG	_S = V _{DS} , I _D = 250μA		2.5	-	3.5	V
R _{DS(on)}		Drain to Source On Resistanc	-	$_{\rm S} = 10V, I_{\rm D} = 7.5A$		-	0.22	0.26	Ω
9FS	Forwar	d Transconductance	VDS	_S = 20V, I _D = 7.5A		-	15.5	-	S
Dynamic C	haract	eristics							
C _{iss}		apacitance				-	1880	2500	pF
C _{oss}		Capacitance		$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz		-	1330	1770	pF
C _{rss}	Revers	e Transfer Capacitance	T =			-	85	130	pF
C _{oss}	Output	Capacitance	V _{DS}	_S = 380V, V _{GS} = 0V, f = 1M	lHz	-	32	-	pF
C _{oss} eff.	Effectiv	e Output Capacitance	V _D s	$_{\rm S}$ = 0V to 480V, V _{GS} = 0V		-	129	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V				-	48	62	nC
Q _{gs}	Gate to	Source Gate Charge		V _{DS} = 380V, I _D = 7.5A V _{GS} = 10V		-	7.4	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge	۷G				17	-	nC
ESR	Equiva	ent Series Resistance	f =	f = 1MHz			5.8	-	Ω
Switching (Charac	teristics							
	1	n Delay Time				<u></u>	20	50	ns
d(on)		n Rise Time	Vor	$V_{DD} = 380V, I_D = 7.5A$ $V_{GS} = 10V, R_G = 4.7\Omega$			11	32	ns
t d(off)		ff Delay Time				_	89	188	ns
f		ff Fall Time			(Note 4)	-	13	36	ns
		de Characteristics			()				
s	-	Im Continuous Drain to Source	e Diode For	ward Current		-		15	А
SM	Maximum Continuous Drain to Source L Maximum Pulsed Drain to Source Diode					-	·	45	A
V _{SD}		ain to Source Diode Forward Voltage		$_{\rm S} = 0$ V, $I_{\rm SD} = 7.5$ A		-	-	1.2	V
rr		e Recovery Time		$V_{GS} = 0V, I_{SD} = 7.5A$ $V_{GS} = 0V, I_{SD} = 7.5A$ $dI_F/dt = 100A/\mu s$		-	270	-	ns
 ຊ _{rr}		e Recovery Charge				-	3.6	-	μC

FCPF260N60E_F152 — N-Channel MOSFET

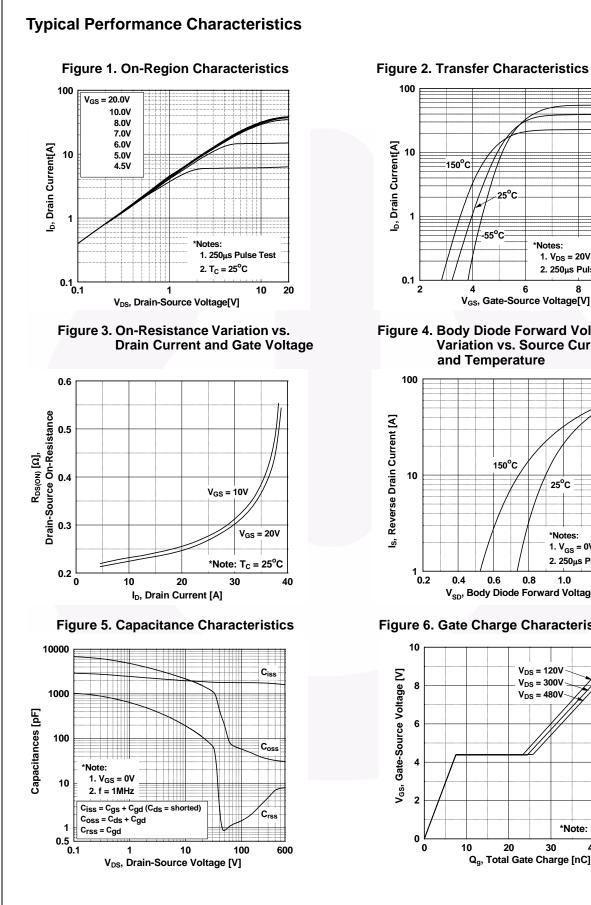


Figure 2. Transfer Characteristics

25°C

*Notes:

6

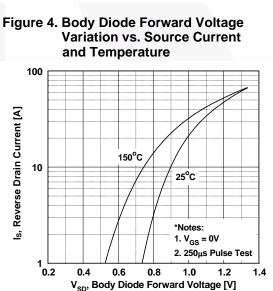
1. V_{DS} = 20V

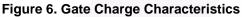
2. 250µs Pulse Test

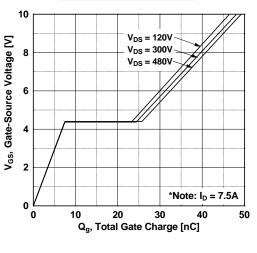
8

10

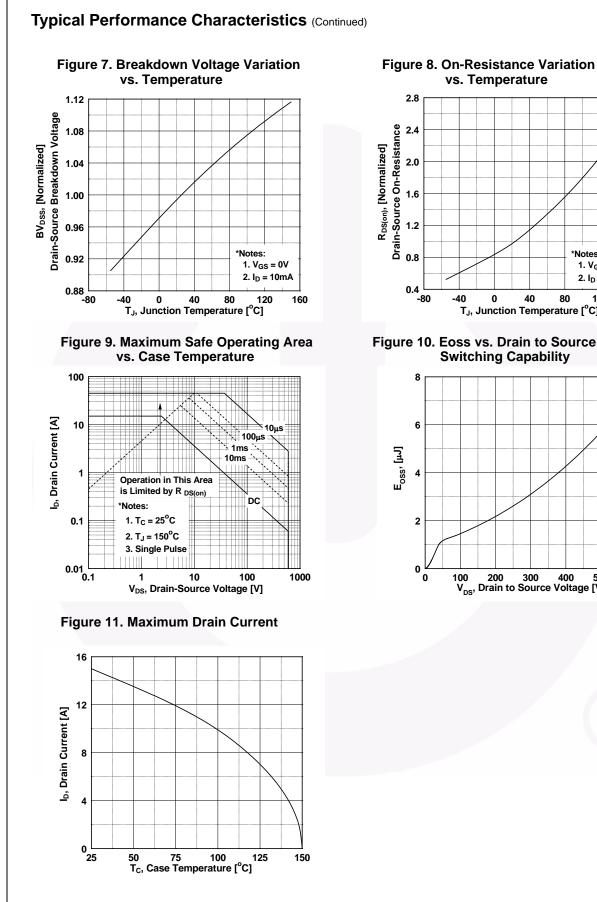
-55°C





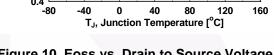


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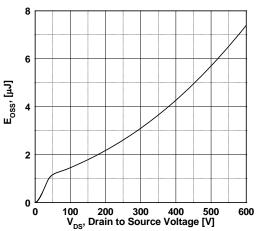


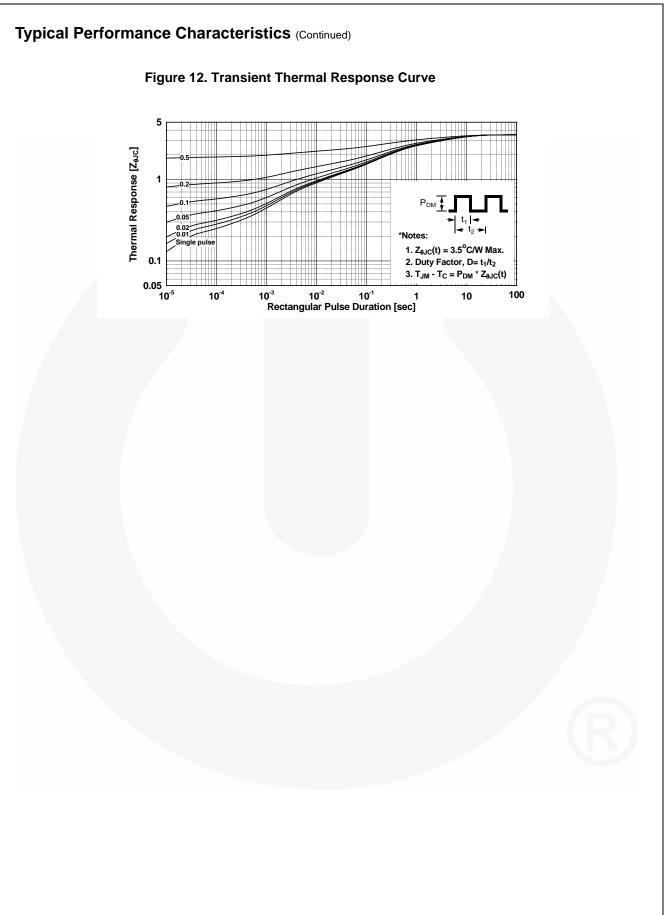
*Notes:

1. V_{GS} = 10V

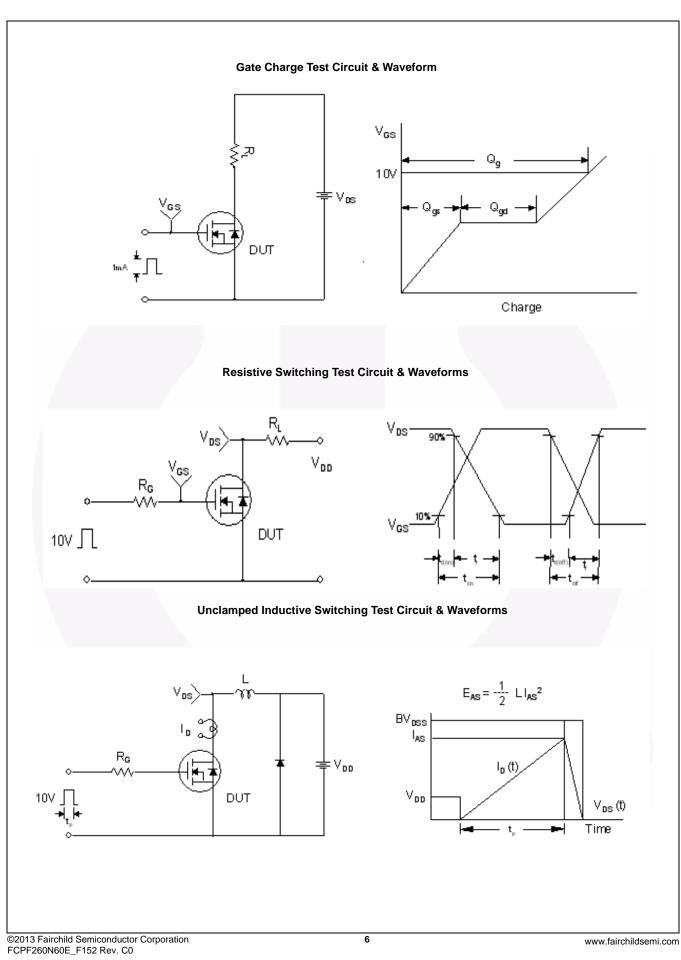
2. I_D = 7.5A

Figure 10. Eoss vs. Drain to Source Voltage Switching Capability



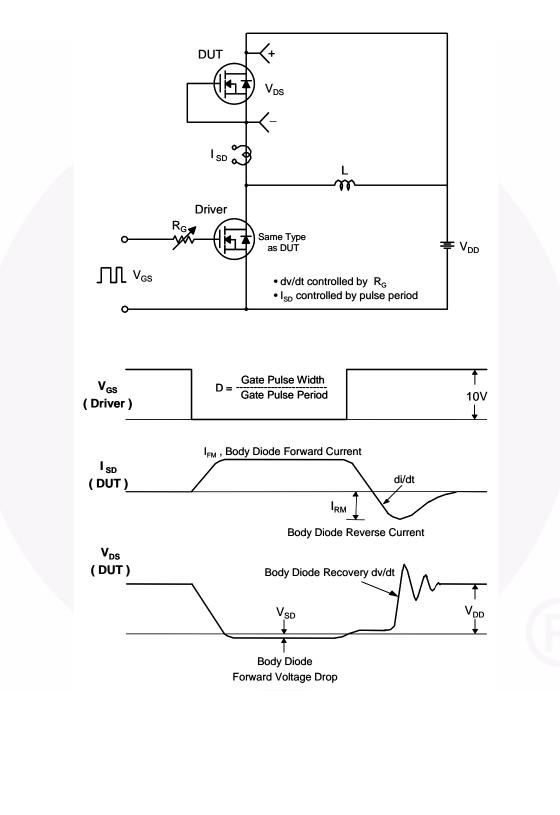


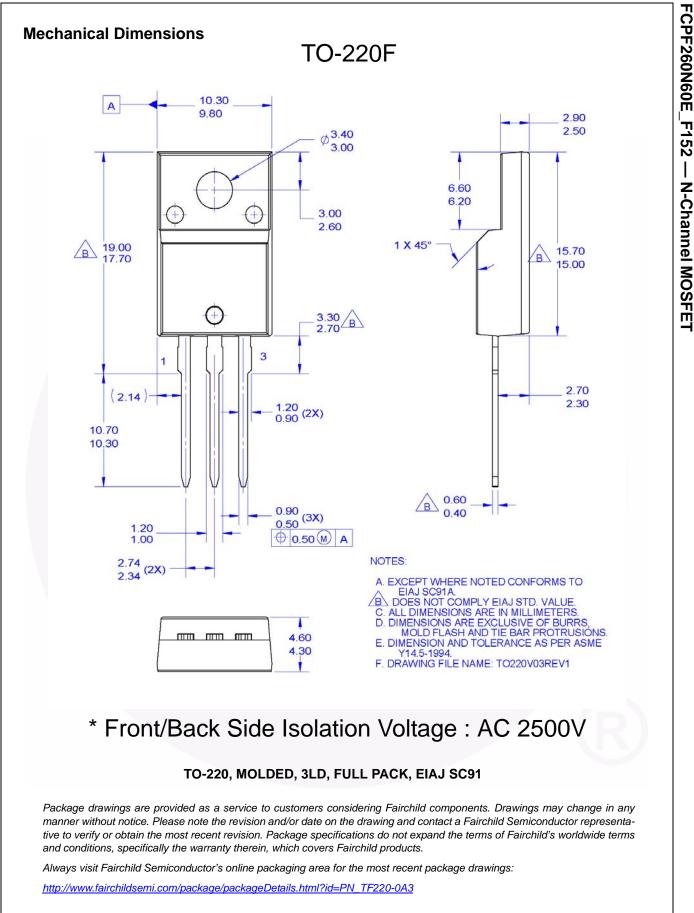
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